N-Channel 100 V (D-S) MOSFET

Q_g (Typ.)

21.5 nC

I_D (A)^a

75

FEATURES

- DT-Trench Power MOSFET
- nd UIS Tested
- · low on-resistance RDS(on)
- Pb-free lead plating

APPLICATIONS

- DC/DC Converter
- hing

D

N-Channel MOSFET

Ideal for high-frequency switch
and synchronous rectification

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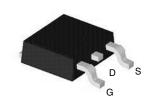
ABSOLUTE MAXIMUM RATINGS ($T_c = 25 \ ^{\circ}C$, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage	V _{DS}	100	- V		
Gate-Source Voltage	V _{GS}	± 20			
Continuous Drain Current ($T_J = 175 \ ^{\circ}C$) ^a	T _C = 25 °C		75	A	
	T _C = 100 °C	I _D	56		
Pulsed Drain Current ^b	I _{DM}	225			
Single Avalanche Energy		E _{AS}	385	mJ	
Maximum Power Dissipation ^c	T _C = 25 °C		175	W	
	T _C = 100 °C	FD	70	vv	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +175	°C	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-Ambient (PCB Mount) ^d	t ≤ 10 s	R _{thJA}	45	°C/W	
Junction-to-Case (Drain)	Steady State	R _{thJC}	0.85	0/10	

Notes

a. Calculated continuous current based on maximum allowablejunction temperature.

- b. Repetitive rating; pulse width limited by max. junction temperature.
- c. Pd is based on max. junction temperature, using junction-case thermal resistance.
- d. The value of ReuA is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with Ta=25 °C.



TO-252 Pin Configuration

Top View





V_{DS} (V)

100

PRODUCT SUMMARY

R_{DS(on)} (mΩ)(Typ.)

12 at V_{GS} = 10 V

17.5 at V_{GS} = 4.5 V

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static				1			
Drain-Source Breakdown Voltage	V _{DS}	V_{GS} = 0 V, I _D = 250 μ A	100	-	-	V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	2	-	3.5	v	
Gate-Body Leakage	I _{GSS}	V_{DS} = 0 V, V_{GS} = ± 20 V	-	-	± 100	nA	
Zara Cata Valtaga Drain Current	1	$V_{DS} = 100 V, V_{GS} = 0 V$	-	-	1	μΑ	
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 80 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$	-	-	100		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	75	-	-	А	
Drain Source On State Desistance d	D	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	-	12	17	- mΩ	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 15 \text{ A}$	-	17.5	24		
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 5 V, I_{D} = 20 A$	-	30	-	S	
Dynamic ^b				1			
Input Capacitance	C _{iss}		-	1320	-	pF	
Output Capacitance	C _{oss}	V_{GS} = 0 V, V_{DS} = 50 V, f = 1 MHz	-	348	-		
Reverse Transfer Capacitance	C _{rss}		-	5	-		
Total Gate Charge ^c	Qg		-	21.5	-		
Gate-Source Charge ^c	Q _{gs}	V_{DS} = 50 V, V_{GS} = 10 V, I_{D} = 20 A	-	3.05	-	nC	
Gate-Drain Charge ^c	Q _{gd}		-	4	-		
Gate Resistance	R _g	f = 1 MHz	-	1.2	-	Ω	
Turn-On Delay Time ^c	t _{d(on)}		-	14	-		
Rise Time ^c	t _r	$V_{DD} = 50 \text{ V}, \text{ I}_{D} = 20 \text{ A}, \text{ R}_{g} = 2 \Omega$	-	10	-	20	
Turn-Off Delay Time ^c	t _{d(off)}	V _{GS} = 10 V	-	30	-	ns	
Fall Time ^c	t _f		-	6	-		
Drain-Source Body Diode Ratings and	Characterist	ics ^b (T _C = 25 °C)					
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C	-	-	75	А	
Pulsed Current	I _{SM}		-	-	225	А	
Forward Voltage ^a	V _{SD}	$I_{F} = 1 \text{ A}, V_{GS} = 0 \text{ V}$	-	-	1.2	V	
Reverse Recovery Time	t _{rr}	I _F = 20 A, di/dt = 100 A/μs	-	55	-	ns	
Reverse Recovery Charge	Q _{rr}	$r_F = 20$ A, $ar/at = 100$ A/µs	-	72	-	nC	

Notes

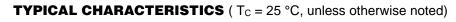
a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

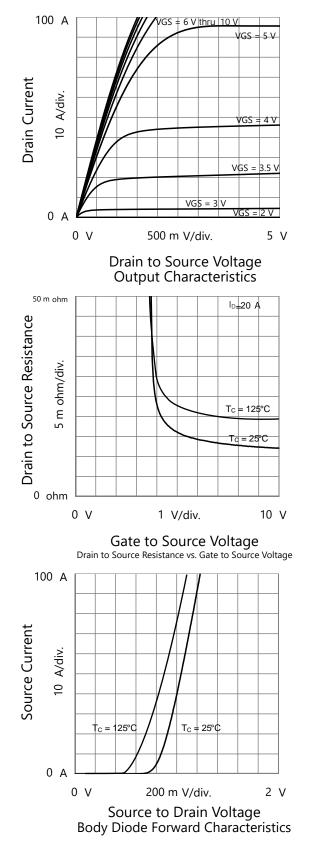
b. Guaranteed by design, not subject to production testing.

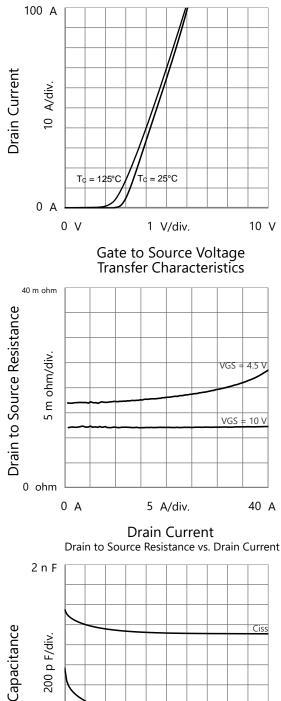
c. Independent of operating temperature.

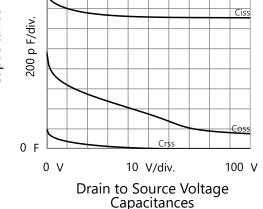
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





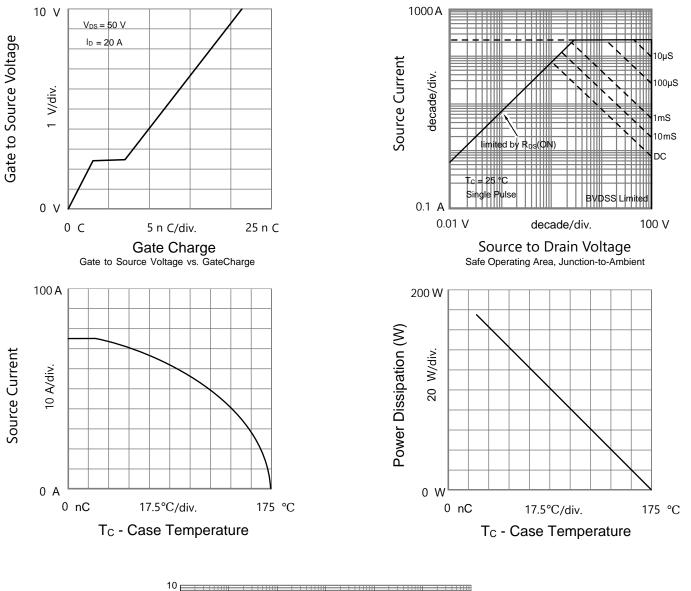


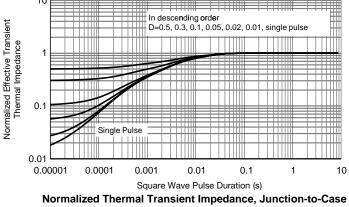




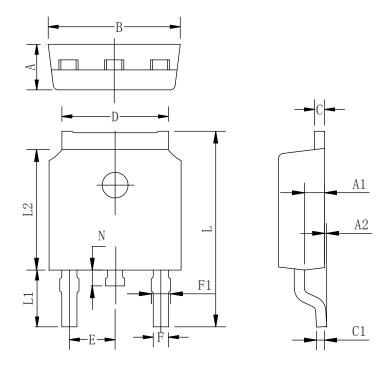


TYPICAL CHARACTERISTICS ($T_C = 25$ °C, unless otherwise noted)





TO-252-2L PACKAGE OUTLINE



COMMON DIMENSIONS (UNITS OF MEASURE=MILLIMETER)

Symbol	Min	Тур	Max	
A	2.10	2.30	2.50	
A1	0.88	1.01	1.16	
A2	0.00	0.15	0.28	
В	6.40	6.60	6.80	
С	0.42	0.50	0.63	
C1	0.42	0.50	0.63	
D	5.08	5.32	5.65	
Е	2.286 TYP			
F	0.63	0.76	0.89	
F1	0.64	0.86	1.08	
L	9.30	9.90	10.80	
L1	2.4	2.8	3.6	
L2	5.90	6.10	6.55	
N	0.57	0.80	1.05	



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